

PACKAGE DIMENSIONS

0.4 INCH (10.2MM) THREE DIGIT STICK DISPLAY

BRIGHT RED MST4111C, MST4141C GREEN MST4411C, MST4441C HIGH EFF. RED MST4911C, MST4941C

$\begin{array}{c} 7.00 \ (0.28) \\ \hline \\ \hline \\ 1.30 \ (0.051) \end{array}$

FEATURES

Easy to read digits. 3 digit common anode or cathode. Low power consumption. Bold segments that are highly visible. High brightness with high contrast White segments on a grey face. Directly compatible with integrated circuits.

Rugged plastic/epoxy construction.

APPLICATIONS

Digital readout displays. Instrument panels.

NOTES: Dimensions are in mm (inch). All pins are 0.5 (0.02) diameter Tolerances are ± 0.25 (0.1) unless otherwise noted.

MODEL NUMBERS

=12.7 (0.50)

Description Part number Color 3 Digit, Common Anode, RHDP. **Bright Red MST4111C Bright Red** 3 Digit, Common Cathode, RHDP. **MST4141C** 3 Digit, Common Anode, RHDP. Green **MST4411C** 3 Digit, Common Cathode, RHDP. Green **MST4441C** High Eff. Red 3 Digit, Common Anode, RHDP. **MST4911C** 3 Digit, Common Cathode, RHDP. **MST4941C** High Eff. Red (For other color options, contact your local area Sales Office).



ABSOLUTE MAXIMUM RATING (TA=25°C unless otherwise specified)

	B.Red	Green	High Eff. Red	
	MST	MST	MST	
	4111C	4411C	4911C	
Part number	4141C	4441C	4941C	Unit
Continuous forward current (I,)				
Per Segment	15	25	25	mA
Peak forward current per die (I _f) (at f = 10 KHz, Duty factor = 1/10)	60	90	90	mA
Power dissipation (P _D)	40*	70*	70*	mW
*Derate Linearly from 25°C	0.17	0.33	0.33	mW/°C
Reverse voltage per dice				5V
Operating and Storage temperature ra	nge		25°C to ·	+85°C
Lead soldering time (at 1/16 inch from the	bottom of lamp)		5 seconds @ 2	230°C

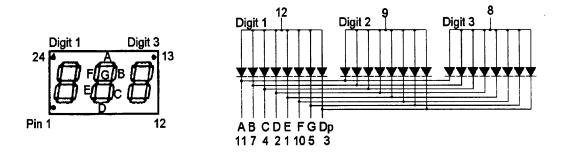
ELECTRO - OPTICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

	B. Red MST	Green MST	High Eff. Red MST	
	4111C	4411C	4911C	Test
<u>Part number</u>	4141C	4441C	4941C	Condition
Luminous intensity (ucd)				
minimum	320	850	800	i , = 20 mA
typical	800	2200	2200	l, = 20 mA
Forward voltage (V,)				
typical	2.1	2.1	2.0	l, = 20 mA
maximum	2.6	2.8	2.8	i , = 20 mA
Peak wavelength (nm)	697	570	635	l, = 20 mA
Spectral line half width (nm)	90	30	45	l, = 20 mA
Reverse breakdown voltage (V _R)	5	5	5	l _r = 100 uA

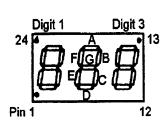


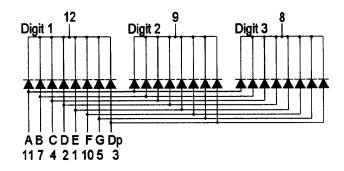
PINOUT

MST4X11C - Common Anode



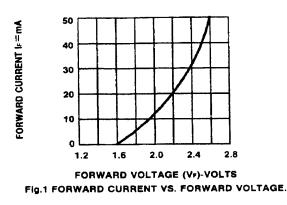
MST4X41C - Common Cathode

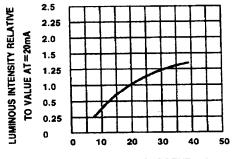






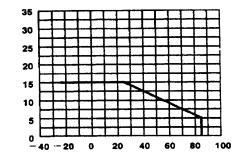
GRAPHICAL DETAIL: Bright Red (T_A = 25°C unless otherwise specified)



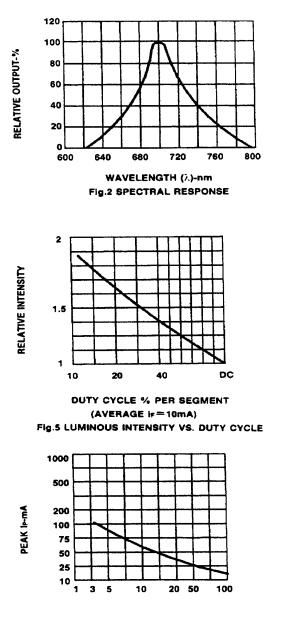








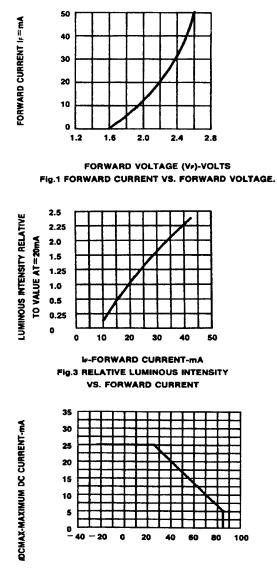
TA AMBIENT TEMPERATURE C Fig.4 MAXIMUM ALLOWABLE DC CURRENT PER SEGMENT VS. A FUNCTION OF AMBIENT TEMPERATURE.



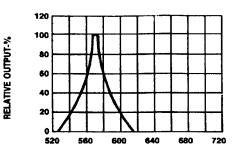
DUTY CYCLE % Fig. 6 MAX PEAK CURRENT VS. DUTY CYCLE % (REFRESH RATE !=1 KHz)



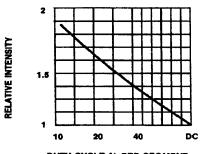
GRAPHICAL DETAIL: Green (T_A = 25°C unless otherwise specified)



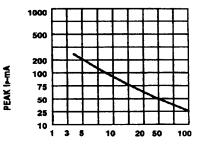




WAVELENGTH (λ)-nm Fig.2 SPECTRAL RESPONSE



DUTY CYCLE % PER SEGMENT (AVERAGE IF=10mA) Fig.5 LUMINOUS INTENSITY VS. DUTY CYCLE

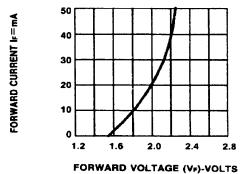


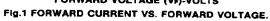
DUTY CYCLE % Fig. 6 MAX PEAK CURRENT VS. DUTY CYCLE % (REFRESH RATE !=1 KHz)

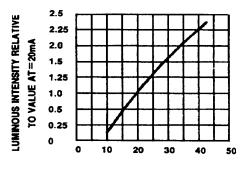


GRAPHICAL DETAIL: High Efficiency Red (T_A = 25°C unless otherwise specified)

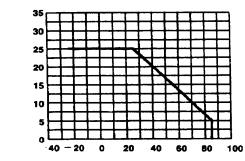
RELATIVE OUTPUT-%







IF-FORWARD CURRENT-MA Fig.3 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT



IDCMAX-MAXIMUM DC CURRENT-mA

TA AMBIENT TEMPERATURE C Fig.4 MAXIMUM ALLOWABLE DC CURRENT PER SEGMENT VS. A FUNCTION OF AMBIENT TEMPERATURE.

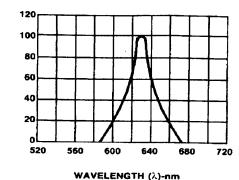
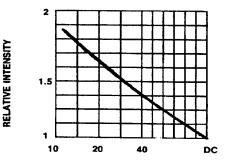
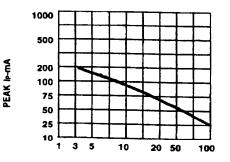


Fig.2 SPECTRAL RESPONSE



DUTY CYCLE % PER SEGMENT (AVERAGE I=10mA) Fig.5 LUMINOUS INTENSITY VS. DUTY CYCLE







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